

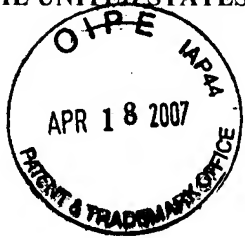
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Rajiv Yadav RANJAN, et al.

Application No.: 10/776,203

Filed: February 12, 2004



Customer Number: 49745

Confirmation Number: 2760

Group Art Unit: 1753

Examiner: McDonald, Rodney Glenn

For: METHOD & APPARATUS FOR MULTI-STAGE SPUTTER DEPOSITION OF UNIFORM THICKNESS LAYERS

Mail Stop Amendment
 Commissioner for Patents
 P.O. Box 1450
 Alexandria, VA 22313-1450

Dear Sir:

Transmitted herewith is an Amendment in the above-identified application.

- ☒ No additional fee is required.
☒ Applicant is entitled to small entity status under 37 CFR 1.27
☒ Also attached: Two (2) Replacement Drawing Sheets

The fee has been calculated as shown below:

	NO. OF CLAIMS	HIGHEST PREVIOUSLY PAID FOR	EXTRA CLAIMS	RATE	FEE
Total Claims	22	23	0	\$50.00 =	\$0.00
Independent Claims	3	3	0	\$200.00 =	\$0.00
Multiple dependent claims newly presented					\$0.00
Fee for extension of time					\$0.00
					\$0.00
Total of Above Calculations					\$0.00

- ☐ Please charge my Deposit Account No. 500417 in the amount of \$0.00. An additional copy of this transmittal sheet is submitted herewith.
- ☒ The Commissioner is hereby authorized to charge payment of any fees associated with this communication or credit any overpayment, to Deposit Account No. 500417, including any filing fees under 37 CFR 1.16 for presentation of extra claims and any patent application processing fees under 37 CFR 1.17.

Respectfully submitted,

McDERMOTT WILL & EMERY LLP.

Bernard P. Codd

Registration No. 46,429

600 13th Street, N.W.
 Washington, DC 20005-3096
 Phone: 202.756.8000 BPC:kap
 Facsimile: 202.756.8087
 Date: April 18, 2007

Please recognize our Customer No. 49745 as our
 correspondence address.



Docket No.: 050103-0553

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of	:	Customer Number: 49745
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Rajiv Yadav RANJAN, et al.	:	Confirmation Number: 2760
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AMENDMENT

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

The following Remarks and Amendment are submitted in response to the Office Action dated January 18, 2007.

Amendments to the specification begin on page 2 of this paper.

Amendments to the drawings begin on page 6 of this paper and include attached replacement sheets.

Amendments to the claims begin on page 7 of this paper.

Remarks begin on page 13 of this paper.